

BRMMBT3904Q

Rev.B May.-2025

/ Descriptions

SOT-23

NPN

Silicon NPN transistor in a SOT-23 Plastic Package.

/ Features

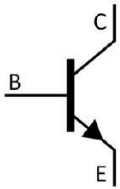
AEC-Q101

Low current, Low voltage, Qualified to AEC-Q101 Standards for High Reliability, HF Product.

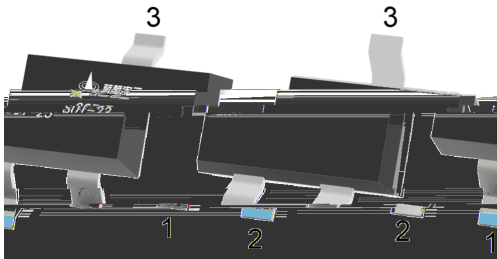
/ Applications

General purpose amplifier and switching, Meet the stringent requirements of automotive applications.

/ Equivalent Circuit



/ Pinning



PIN 1 Base

PIN 2 Emitter

PIN 3 Collector

/ hFE Classifications & Marking

hFE Range	100 300
Marking	· Q1A

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DATA SHEET

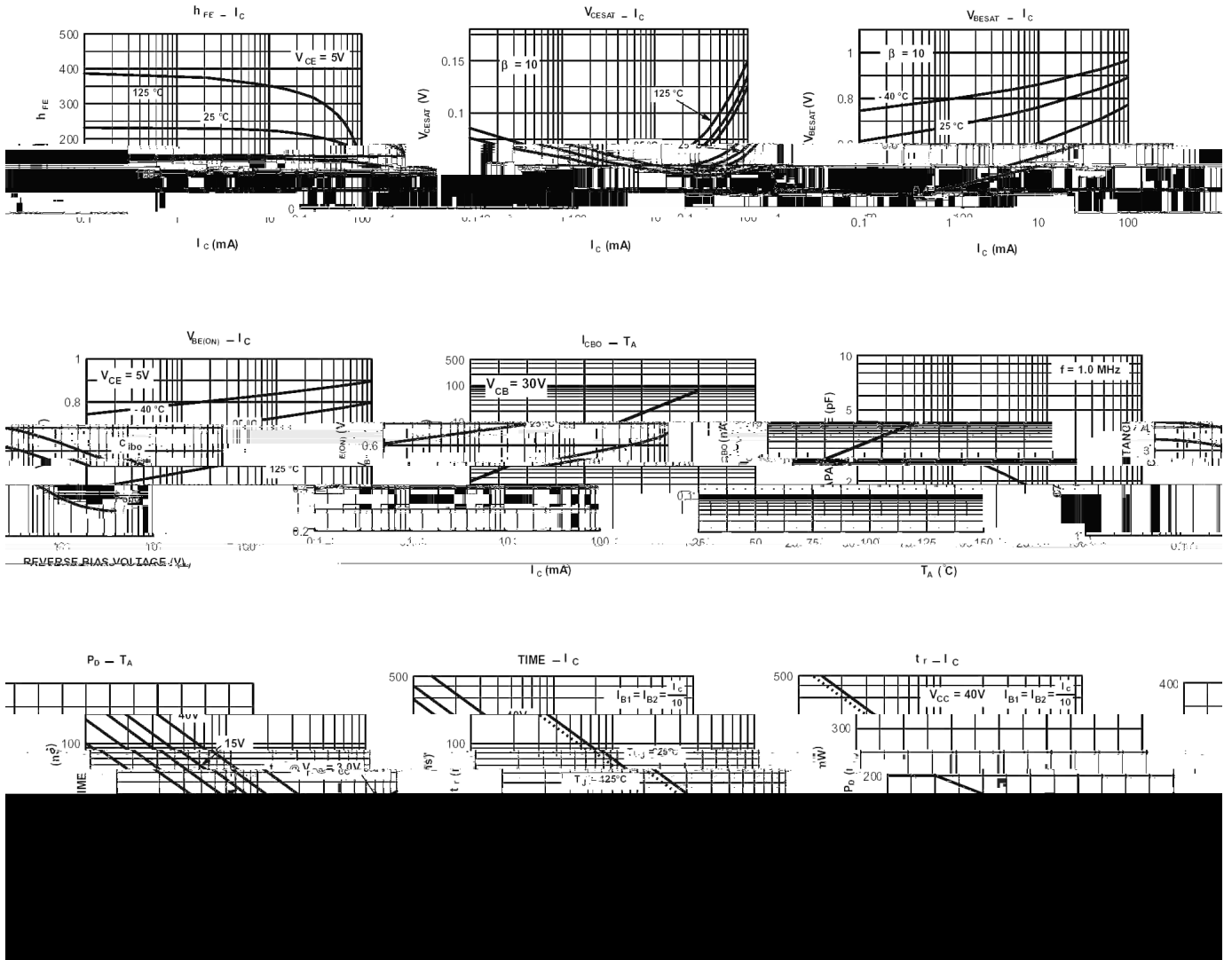
Parameter	Symbol	Rating	Unit
Collector to Base Voltage	V_{CBO}	60	V
Collector to Emitter Voltage	V_{CEO}	40	V
Emitter to Base Voltage	V_{EBO}	6.0	V
Collector Current	I_C	200	mA
Collector Power Dissipation	P_C	200	mW
Collector Power Dissipation	* P_C	350	mW
Junction Temperature	T_j	150	
Storage Temperature Range	T_{stg}	-55 150	

* 7×5×0.6mm

*When mounted on a 7×5×0.6mm ceramic board

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Collector to Base Breakdown Voltage	V_{CBO}	$I_C=10\mu A$ $I_E=0$	60			V
Collector to Emitter Breakdown Voltage	V_{CEO}	$I_C=1.0mA$ $I_B=0$	40			V

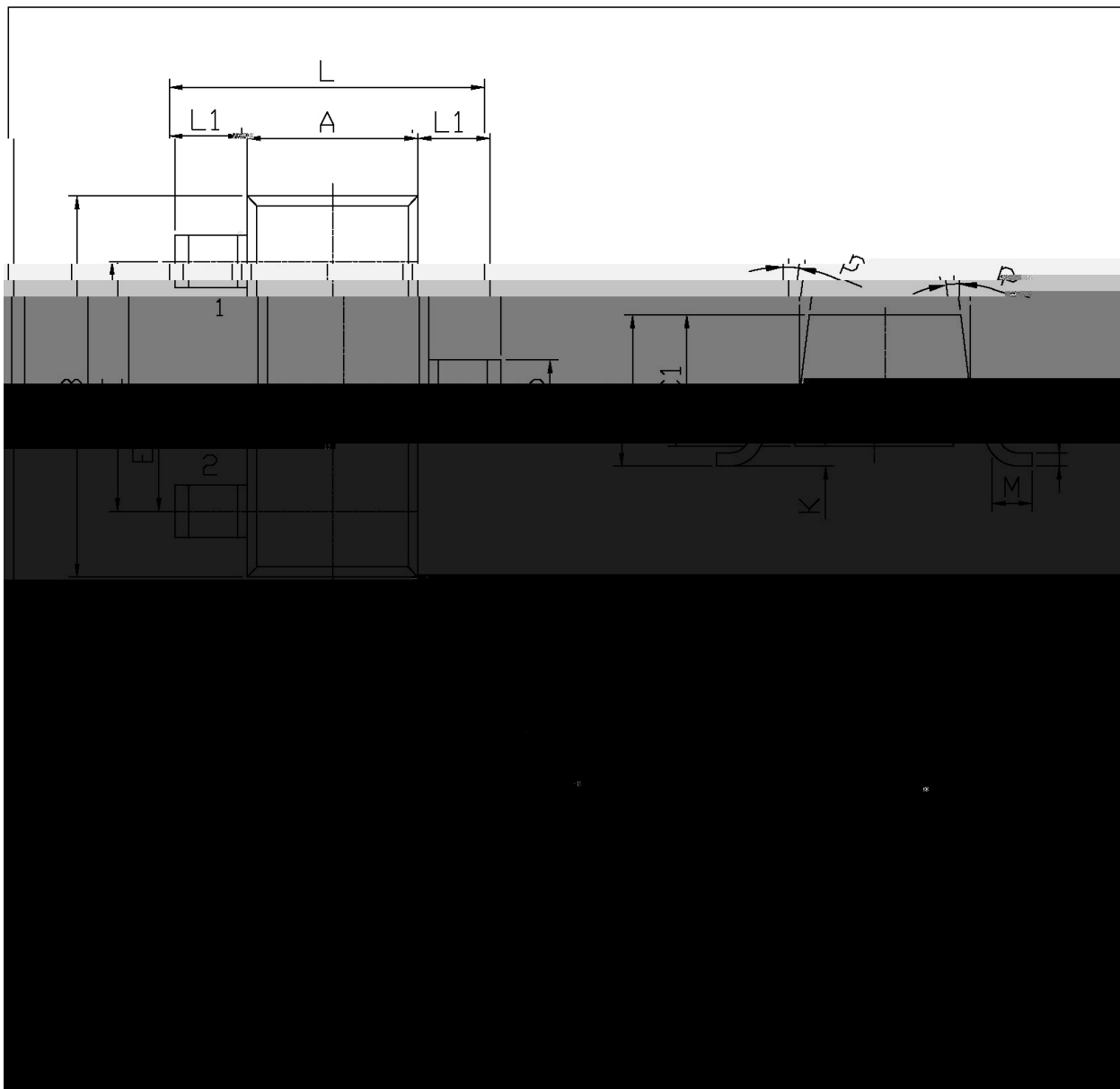
/ Electrical Characteristic Curve



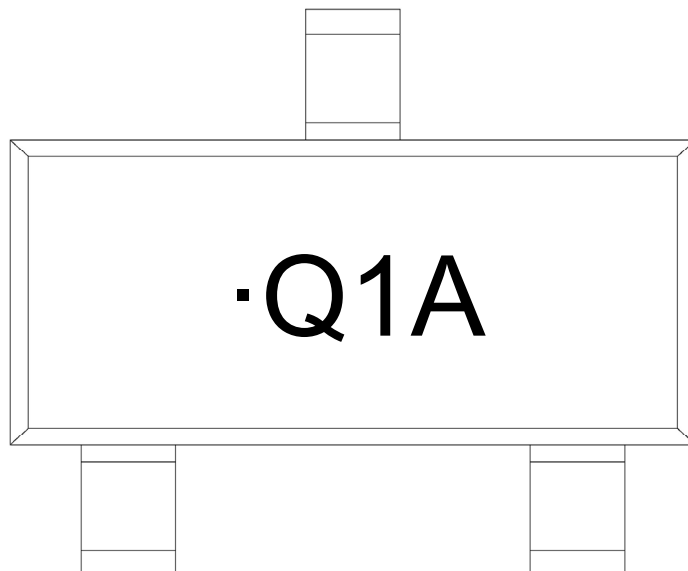
/ Package Dimensions

SOT-23

单位: mm



/ Marking Instructions



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Q

1A

Note:

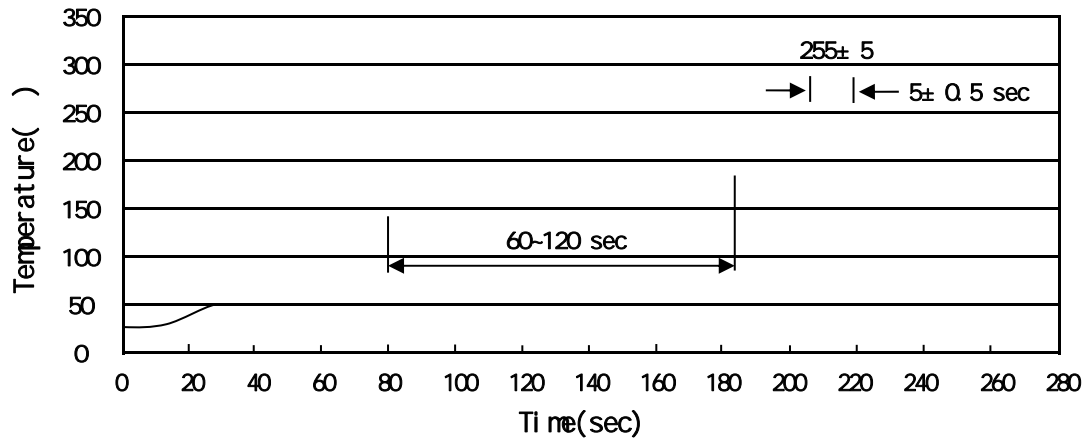
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Identify

Q: Automobile halogen-free product Code

1A Product Type Code

() / Temperature Profile for IR Reflow Soldering(Pb-Free)



Note:

- 1 150 200 60 120sec; 1.Preheating:150~200 , Time:60~120sec.
- 2 255±5 5±0.5sec; 2.Peak Temp.:255±5 , Duration:5±0.5sec.
- 3 2 10 /sec. 3. Cooling Speed: 2~10 /sec.

/ Resistance to Soldering Heat Test Conditions

260±5 10±1 sec. Temp.:260±5 Time:10±1 sec

/ Packaging SPEC.

/ REEL

Package Type	Units					Dimension (unit mm ³)		
	Units/Reel	Reels/Inner Box	Units/Inner Box	Inner Boxes/Outer Box	Units/Outer Box	Reel	Inner Box	Outer Box
SOT-23	3,000	10	30,000	6	180,000	7 ×8	180×120×180	390×385×205

/ Notices